

**Vishay Siliconix** 

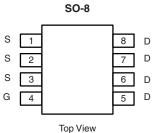
RoHS

COMPLIANT HALOGEN

FREE

## P-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	<b>R<sub>DS(on)</sub> (</b> Ω)	I <sub>D</sub> (A) <sup>d</sup>	Q <sub>g</sub> (Typ.)			
- 30	0.0088 at V <sub>GS</sub> = - 10 V	- 19.2	44.8 nC			
	$0.0153  \text{at}  \text{V}_{\text{GS}} = -4.5  \text{V}$	- 14.6	44.0110			

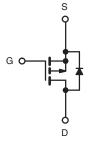


### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> Tested
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

· Adaptor Switch



Ordering Information: Si4483ADY-T1-GE3 (Lead (Pb)-free and Halogen-free)

P-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b> (T	A = 25 °C, unless oth	erwise noted)	)	
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	- 30	V	
Gate-Source Voltage	V <sub>GS</sub>	± 25	v	
	T <sub>C</sub> = 25 °C		- 19.2	
Continuous Drain Current (T <sub>1</sub> = 150 °C)	T <sub>C</sub> = 70 °C		- 15.4	
Continuous Drain Guneni (1) = 150 (C)	T <sub>A</sub> = 25 °C	טי	- 13.5 <sup>a, b</sup>	
	T <sub>A</sub> = 70 °C	] [	- 10.9 <sup>a, b</sup>	A
Pulsed Drain Current	I <sub>DM</sub>	- 70	A	
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C		- 4.9	
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	- I <sub>S</sub> -	- 2.4 <sup>a, b</sup>	
Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	20	
Single-Pulse Avalanche Energy	L = 0.1 IIIH	E <sub>AS</sub>	20	mJ
	T <sub>C</sub> = 25 °C		5.9	
Maximum Dawar Dissinction	T <sub>C</sub> = 70 °C	- P <sub>D</sub> -	3.8	w
Maximum Power Dissipation	T <sub>A</sub> = 25 °C		2.9 <sup>a, b</sup>	vv
	T <sub>A</sub> = 70 °C	] [	1.9 <sup>a, b</sup>	
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient <sup>a, c</sup>	t ≤ 10 s	R <sub>thJA</sub>	33	42	°C/W		
Maximum Junction-to-Foot	Steady State	R <sub>thJF</sub>	16	21	0/00		

Notes:

a. Surface mounted on 1" x 1" FR4 board.

c. Maximum under steady state conditions is 85 °C/W.

d. Based on T<sub>C</sub> = 25 °C.

b. t = 10 s.

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Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static	<b>j</b>			.,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,		•
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = - 250 μA	- 30			V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	- I <sub>D</sub> = - 250 μΑ		- 30		- mV/°C
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			5.3		
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 1.2	- 2.1	- 2.6	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 25 V$			± 100	nA
-		$V_{\rm DS} = -30$ V, $V_{\rm GS} = 0$ V			- 1	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 \text{ °C}$			- 5	μA
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge -10 \text{ V}, \text{ V}_{GS} = -10 \text{ V}$	- 30			A
		V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 10 A		0.0073	0.0088	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 7 A			0.0153	Ω
Forward Transconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 10 A		32		S
Dynamic <sup>b</sup>						
Input Capacitance	C <sub>iss</sub>			3900		pF
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		715		
Reverse Transfer Capacitance	C <sub>rss</sub>			645		
		V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 10 A		90	135	
Total Gate Charge	Qg			44.8	68	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ = - 15 V, $V_{GS}$ = - 4.5 V, $I_{D}$ = - 10 A		12.2		
Gate-Drain Charge	Q <sub>gd</sub>			21.7		
Gate Resistance	R <sub>g</sub>	f = 1 MHz	0.4	1.8	3.6	Ω
Turn-On Delay Time	t <sub>d(on)</sub>			14	28	
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 15 V, $R_L$ = 1.5 $\Omega$		13	25	
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong$ - 10 A, $V_{GEN}$ = - 10 V, $R_g$ = 1 $\Omega$		49	90	
Fall Time	t <sub>f</sub>			13	25	
Turn-On Delay Time	t <sub>d(on)</sub>			70	120	ns
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 15 V, $R_L$ = 1.5 $\Omega$		150	280	-
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong$ - 10 A, $V_{GEN}$ = - 4.5 V, $R_g$ = 1 $\Omega$		43	80	
Fall Time	t <sub>f</sub>			28	55	
Drain-Source Body Diode Characterist	tics					1
Continous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			- 4.9	
Pulse Diode Forward Current	I <sub>SM</sub>				- 70	A
Body Diode Voltage	V <sub>SD</sub>	$I_{S} = -3 \text{ A}, V_{GS} = 0 \text{ V}$		- 0.72	- 1.2	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>			41	70	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = - 10 A, dl/dt = 100 A/μs, T <sub>.1</sub> = 25 °C		41	70	nC
Reverse Recovery Fall Time	t <sub>a</sub>			18		
Reverse Recovery Rise Time	t <sub>b</sub>			23		ns

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

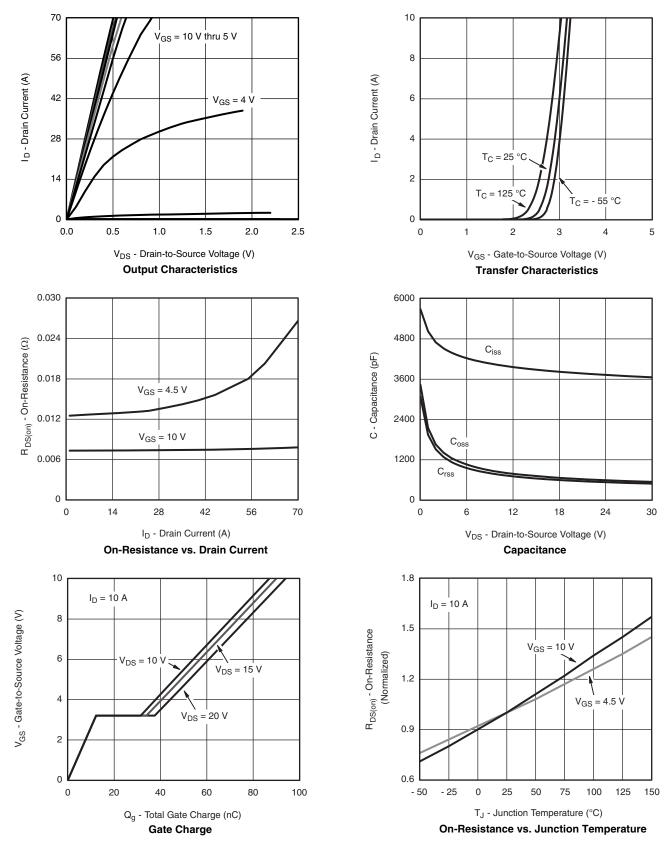
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



## Si4483ADY Vishay Siliconix

## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



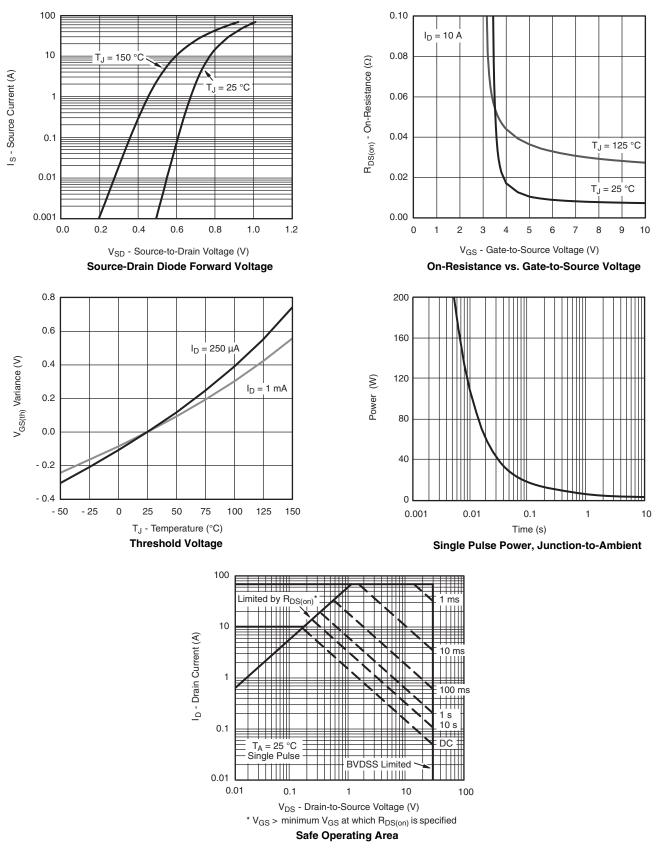
Document Number: 68982 S10-2543-Rev. B, 08-Nov-10

# Si4483ADY

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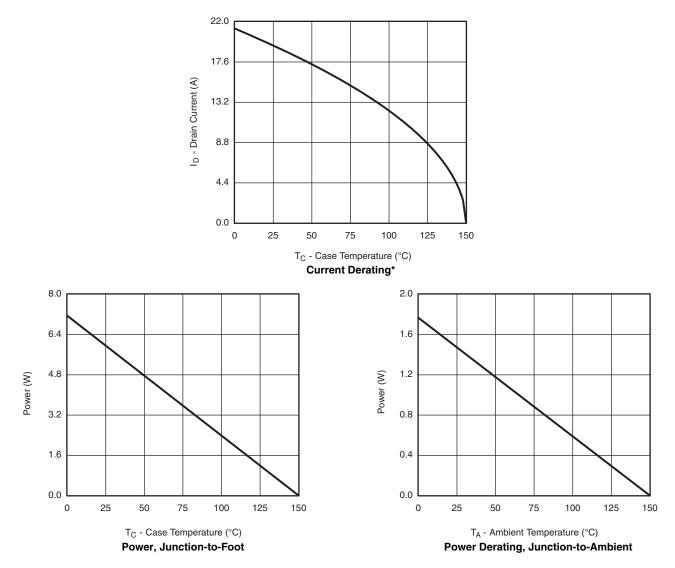


## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





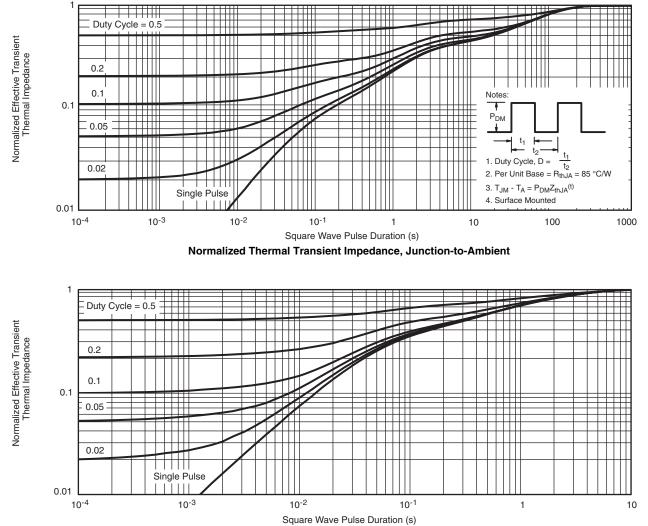
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?68982">www.vishay.com/ppg?68982</a>.



# Package Information

Vishay Siliconix

# SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INCHES			
DIM	Min	Мах	Min	Max		
A	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27 BSC		0.050 BSC			
н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498						

# **Application Note 826**

Vishay Siliconix



**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)

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